



BSI Standards Publication

Test methods for electrical materials, printed boards and other interconnection structures and assemblies

Part 2-803: Test methods for Z-axis expansion of
base materials and printed boards

National foreword

This British Standard is the UK implementation of EN IEC 61189-2-803:2023. It is identical to IEC 61189-2-803:2023.

The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic Assembly Technology.

A list of organizations represented on this committee can be obtained on request to its committee manager.

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